

The NJW4140 is a MOSFET drive switching regulator IC

for Boost/Fly-back Converter that operates wide input

range from 3V to 40V. It can provide large current

application because of built-in highly effective Nch

Built-in pulse-by-pulse current detecting type over current

protection limits the output current at over load.

### **MOSFET Drive Switching Regulator IC for Boost/Fly-back Converter**

DESCRIPTION

MOSFET drive circuit.

#### FEATURES

- Nch MOSFET driving Driving voltage 5.3V (typ.)
- Wide operating voltage 3V to 40V
- Operating temperature -40°C to 125°C
- PWM control
- Wide oscillating frequency 40kHz to 1MHz
- Over current protection
- Undervoltage lockout (UVLO)
- Standby function
- Package MSOP8 (VSP8)\*

\*MEET JEDEC MO-187-DA

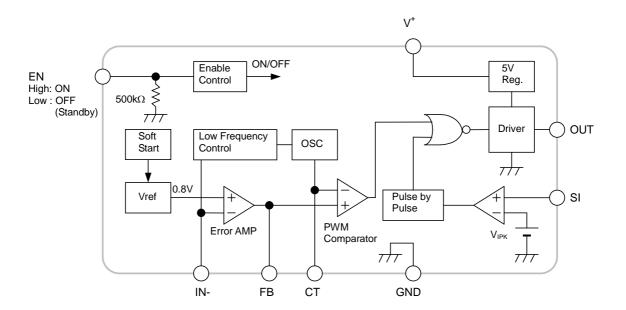
• AEC-Q100 qualification in progress

### ■ APPLICATIONS

### Automotive ECU

• Industrial control equipment

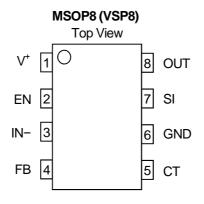
### BLOCK DIAGRAM



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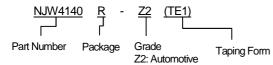


#### ■ PIN CONFIGURATION



PIN NO.	NAME	FUNCTION
1	V*	Power supply pin
2	EN	Enable control pin
3	IN-	Output voltage detecting pin
4	FB	Feedback setting pin
5	СТ	Oscillating frequency setting pin
6	GND	Ground pin
7	SI	Current sensing pin
8	OUT	Output pin

#### ■ PRODUCT NAME INFORMATION



#### ORDERING INFORMATION

PRODUCT NAME	PACKAGE	RoHS	HALOGEN- FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ (pcs)
NJW4140R-Z2 (TE1)	MSOP8 (VSP8)	Yes	Yes	Sn-2Bi	4140Z2	21	2000

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#### ■ ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT
Input Voltage	V <sup>+</sup>	45	V
OUT pin Voltage	Vout	-0.3 to 6 <sup>(1)</sup>	V
SI pin Voltage	V <sub>SI</sub>	-0.3 to 6	V
EN pin Voltage	V <sub>EN</sub>	45	V
IN- pin Voltage	V <sub>IN-</sub>	6	V
CT pin Voltage	V <sub>CT</sub>	6 <sup>(1)</sup>	V
OUT pin Peak Current	I <sub>О_РЕАК+</sub> Iо_реак-	200 (Source) 700 (Sink)	mA
Power Dissipation (T <sub>a</sub> = 25°C) MSOP8 (VSP8)	PD	2-Layer 595 <sup>(2)</sup>	mW
Junction Temperature	Tj	-40 to 150	°C
Storage Temperature	T <sub>stg</sub>	-40 to 150	°C

(1) When Input voltage is less than 6V, the absolute maximum these pin are equal to the Input voltage.

(2) 2-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4).

#### RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V <sup>+</sup>	3 to 40	V
Timing Capacitor	Ст	120 to 3900	pF
Oscillating Frequency	fosc	40 to 1000	kHz
Operating Temperature	T <sub>opr</sub>	-40 to 125	°C

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ELECTRICAL CHARACTERISTICS

 $V^{+} = V_{EN} = 12V, C_T = 470 \text{pF}, T_a = 25^{\circ}\text{C}$ , unless otherwise noted. **TEST CONDITIONS** PARAMETER SYMBOL MIN TYP MAX UNIT OSCILLATOR  $C_T = 470 pF$ 270 300 330 **Oscillation Frequency 1** kHz fosc1  $C_T = 470 pF$ ,  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 260 \_ 330  $C_{T} = 680 pF$ 180 210 240 **Oscillation Frequency 2** kHz fosc2  $C_T = 680 pF$ ,  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 170 240 - $C_{T} = 1500 pF$ 92 100 110 **Oscillation Frequency 3** kHz fosc3 - $C_T = 1500 \text{pF}, T_a = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$ 85 110 150 200 250 Charge Current μΑ I<sub>chg</sub>  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 140 -260 150 200 250 **Discharge Current** μA l<sub>dis</sub>  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 140 \_ 260 Voltage Amplitude 0.7 V Vosc --**Oscillation Frequency Deviation**  $V^{+} = 3V \text{ to } 40V$ **f**<sub>DV</sub> \_ 1 -% (Supply Voltage)  $V_{IN-} = 0.3V, V_{FB} = 0.7V, C_T = 470pF$ 90 105 120 **Oscillation Frequency** kHz fosc\_low V<sub>IN-</sub> = 0.3V, V<sub>FB</sub> = 0.7V, C<sub>T</sub> = 470pF (Low Frequency Control) 70 130 - $T_a = -40^{\circ}C$  to  $125^{\circ}C$ SOFT START  $V_{\rm B} = 0.75 V$ 2 4 8 Soft Start Time T<sub>SS</sub> ms  $V_B = 0.75V$ ,  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 2 8 \_ ERROR AMPLIFIER -1.0% 0.8 +1.0% **Reference Voltage**  $V_{B}$ V  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ -2.0% -+2.0% -0.1 \_ 0.1 Input Bias Current  $I_B$ μΑ  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ -0.1 -0.1 **Open Loop Gain** 80  $A_{V}$ \_ \_ dB Gain Bandwidth Product GB -3 -MHz  $V_{FB} = 1V, V_{IN-} = 0.7V$ 100 150 50 **Output Source Current** μΑ I<sub>OM+</sub>  $V_{FB} = 1V$ ,  $V_{IN-} = 0.7V$ ,  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 50 -150  $V_{FB} = 1V, V_{IN-} = 0.9V$ 2 4 6 **Output Sink Current** mΑ I<sub>OM</sub>- $V_{FB} = 1V$ ,  $V_{IN-} = 0.9V$ ,  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 2 8 -**PWM COMPARATOR** Duty = 0%,  $V_{IN-} = 0.6V$ 0.32 0.40 0.54 V  $V_{T_0}$ Duty = 0%,  $V_{IN-} = 0.6V$ , 0.32 0.54 - $T_a = -40^{\circ}C$  to  $125^{\circ}C$ Input Threshold Voltage (FB pin)  $Duty = 50\%, V_{IN-} = 0.6V$ 0.63 0.70 0.77 V<sub>T 50</sub> V Duty = 50%,  $V_{IN-} = 0.6V$ , 0.63 -0.77  $T_a = -40^{\circ}C$  to  $125^{\circ}C$ 

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 $V_{FB} = 1.2V, T_a = -40^{\circ}C \text{ to } 125^{\circ}C$ 

 $V_{FB} = 1.2V$ 

MAXDUTY

Maximum Duty Cycle

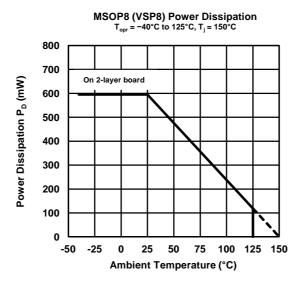
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PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNI	
CURRENT LIMIT DETECTION							
			120	140	160		
Current Limit Detection Voltage	VIPK	$T_a = -40^{\circ}C$ to 125°C	120	-	160	mV	
Delay Time	T <sub>DELAY</sub>	$\Delta V_{SI} = 300 \text{mV}$	-	90	-	ns	
OUTPUT		•					
Output High Level ON Resistance	R <sub>OH</sub>	$I_{O} = -50 \text{mA}$	-	3.0	4.5	Ω	
		$I_{O} = 50 \text{mA}$	-	2.5	3.5	0	
Output Low Level ON Resistance	R <sub>OL</sub>	$I_0 = 50 \text{mA}, T_a = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$	-	-	4.5	Ω	
		OUT pin = 4.5V	45	65	85		
Output Source Current	I <sub>OH</sub>	OUT pin = 4.5V, $T_a = -40^{\circ}C$ to 125°C	40	-	90	mA	
	V		5.00	5.30	5.55	V	
Output pin Limiting Voltage	V <sub>OLIM</sub>	$T_a = -40^{\circ}C$ to 125°C	5.00	-	5.65	V	
UNDER VOLTAGE LOCKOUT		·					
ON Threshold Voltage	V <sub>T_ON</sub>	$V^+ = L \longrightarrow H$	2.65	2.80	2.95	v	
		$V^+$ = L $\rightarrow$ H, T <sub>a</sub> = -40°C to 125°C	2.65	-	2.95		
	N/	$V^+ = H \rightarrow L$	2.40	2.55	2.70	- V	
OFF Threshold Voltage	V <sub>T_OFF</sub>	$V^+$ = H $\rightarrow$ L, T <sub>a</sub> = -40°C to 125°C	2.35	-	2.80		
ENABLE CONTROL							
		$V_{EN} = L \longrightarrow H$	1.7	-	V <sup>+</sup>		
ON Control Voltage	V <sub>ON</sub>	$V_{EN} = L \rightarrow H$ , $T_a = -40^{\circ}C$ to $125^{\circ}C$	1.7	-	V <sup>+</sup>	V	
		$V_{EN} = H \rightarrow L$	0	-	0.9	V	
OFF Control Voltage	VOFF	$V_{EN} = H \rightarrow L$ , $T_a = -40^{\circ}C$ to $125^{\circ}C$	0	-	0.9	V	
Pull-down Resistance	Р		350	500	650	kΩ	
Pull-down Resistance	R <sub>PD</sub>	$T_a = -40^{\circ}C$ to 125°C	350	-	650		
GENERAL CHARACTERISTICS							
		$R_L$ = no load, $V_{IN^-}$ = $V_{FB}$ = 0.7V	-	1.4	1.7		
Quiescent Current	I <sub>DD</sub>	$R_L = no load, V_{IN-} = V_{FB} = 0.7V$ $T_a = -40^{\circ}C to 125^{\circ}C$	-	-	2.0	mA	
Standby Current	I_	$V_{EN} = 0V$	-	2.5	6.0		
Standby Current	IDD_STB	$V_{EN} = 0V, T_a = -40^{\circ}C \text{ to } 125^{\circ}C$	-	-	12.0	μA	

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#### ■ POWER DISSIPATION vs. AMBIENT TEMPERATURE



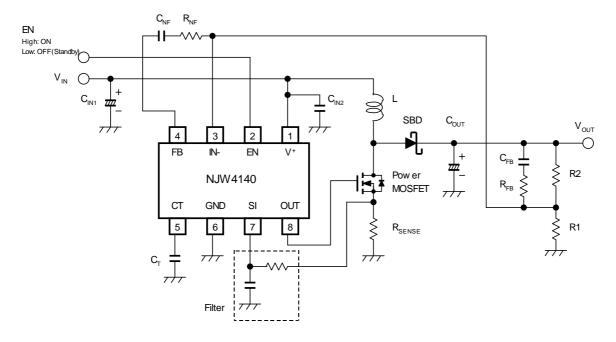
2-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4).

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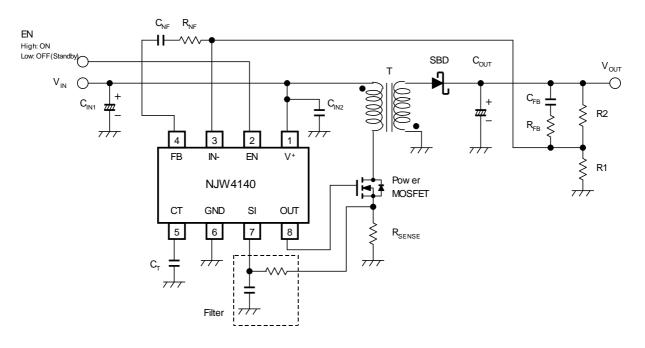


#### ■ APPLICATION EXAMPLE

#### Non-isolated Boost Converter



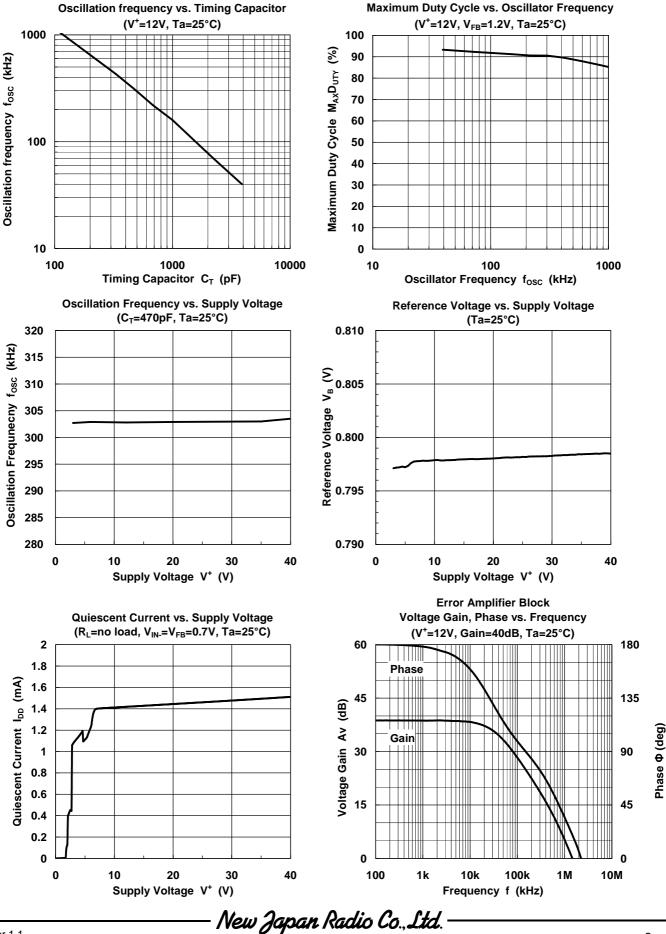
#### Non-isolated Fly-back Converter



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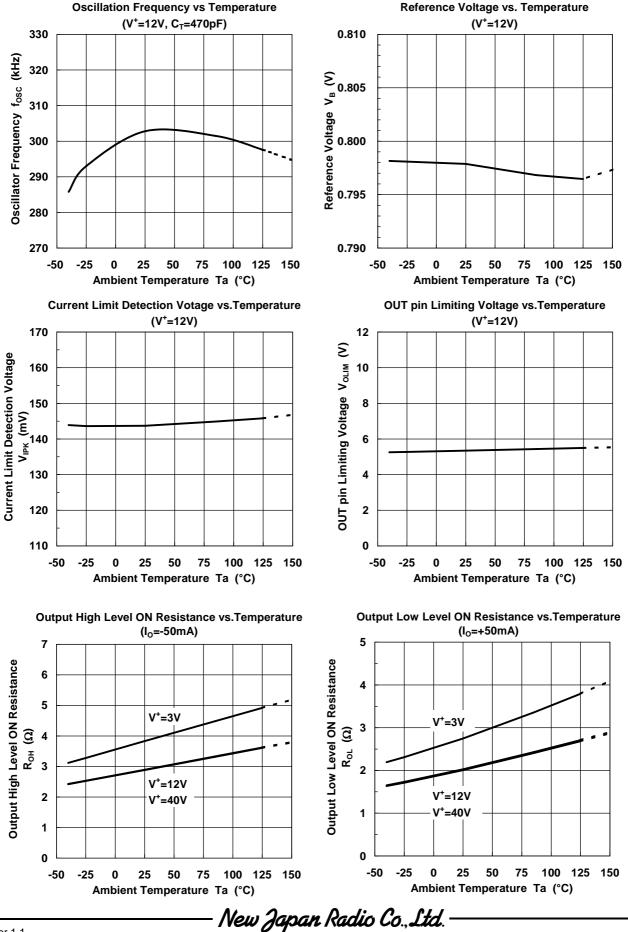






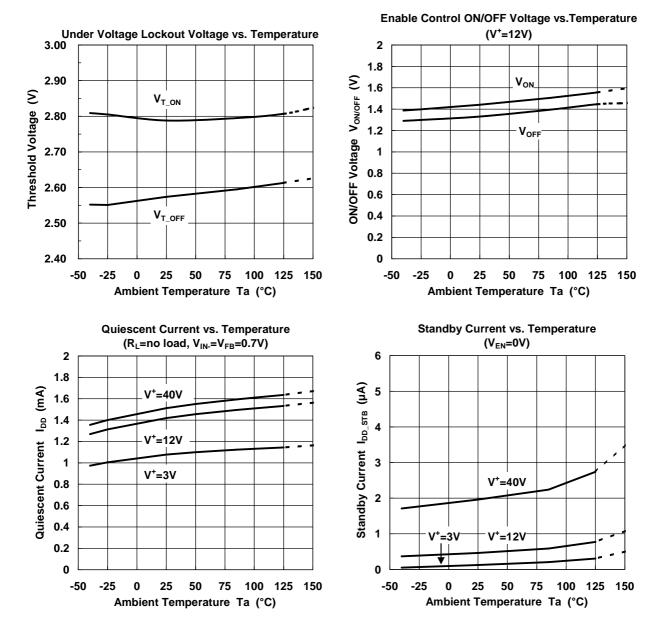


#### ■ TYPICAL CHARACTERISTICS





#### ■ TYPICAL CHARACTERISTICS



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### PIN DESCRIPTIONS

PIN NO.	NAME	FUNCTION
1	V*	Power supply pin
2	EN	Enable control pin The ON/OFF pin internally pulls down with $500k\Omega$ . Normal operation at the time of high level. Standby mode at the time of low level or OPEN.
3	IN-	Output voltage detecting pin Connects output voltage through the resistor divider tap to this pin in order to voltage of the IN- pin become 0.8V.
4	FB	Feedback setting pin The feedback resistor and capacitor are connected between the FB pin and the IN- pin.
5	СТ	Oscillating frequency setting pin by Timing Capacitor Oscillating frequency should set between 40kHz and 1MHz.
6	GND	Ground pin
7	SI	Current sensing pin When difference voltage between the SI pin and the GND pin exceeds 140mV (typ.), over current protection operates.
8	OUT	Output pin for Power MOSFET driving The OUT pin voltage is clamped with 5.3V (typ.) at the time of high level, in order to protect a gate of Nch MOSFET.

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### Description of Block Features

#### Error Amplifier Section (ER-AMP)

0.8V±1% precise reference voltage is connected to the non-inverted input of this section.

To set the output voltage, connects converter's output to inverted input of this section (IN- pin). If requires output voltage over 0.8V, inserts resistor divider.

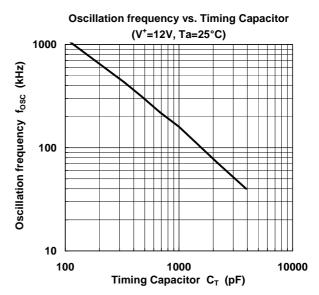
This AMP section has high gain and external feedback pin (FB pin). It is easy to insert a feedback resistor and a capacitor between the FB pin and the IN- pin, making possible to set optimum loop compensation for each type of application.

#### **Oscillation Circuit Section (OSC)**

Oscillation frequency can be set by inserting capacitor between the CT pin and GND. Referring to the sample characteristics in "Timing Capacitor and Oscillation Frequency", set oscillation frequency between 40kHz and 1MHz.

The triangular wave of the oscillating circuit is generated in the IC, having amplitude between 0.4V and 1.0V at  $C_T$  = 470pF (ref.).

If voltage of the IN– pin becomes less than 0.4V, the oscillation frequency decreases to one third (33%) and the energy consumption is suppressed.



#### **PWM Comparator Section (PWM)**

This section controls the switching duty ratio.

PWM comparator receives the signal of the error amplifier and the triangular wave, and controls the duty ratio between 0% and 90%. The timing chart is shown in Fig.1.

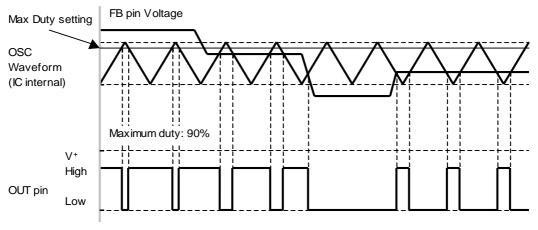


Fig.1. Timing Chart PWM Comparator and OUT pin

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### Description of Block Features (Continued)

**Driver Section (Driver)** 

The output driver circuit is configured a totem pole type, it can efficiently drive a Nch MOSFET switching device. When the output is high level, the OUT pin voltage is clamped with 5.3V (typ.) by the internal regulator to protect gate of Nch MOSFET. (Ref. Fig.2. OUT pin)

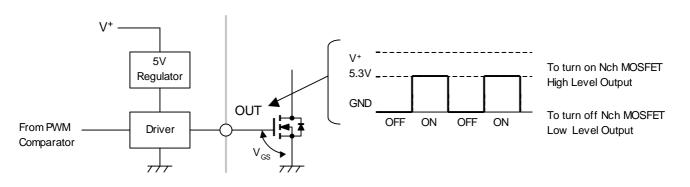


Fig.2. Driver Circuit and the OUT pin Voltage

When supply voltage is decreasing, gate drive voltage output from the OUT pin is also decreasing. Although the OUT pin voltage is kept gate drive voltage by bypassing the internal regulator around supply voltage 5V. Fig.3. shows the example of the OUT pin voltage vs. supply voltage characteristic

The optimum drive ability of MOSFET depends on the oscillation frequency and the gate capacitance of MOSFET.

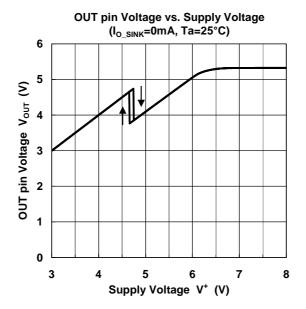


Fig.3. OUT pin Voltage vs. Supply Voltage Characteristic

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### Description of Block Features (Continued)

#### Power Supply, GND pin (V<sup>+</sup>, GND)

In line with MOSFET drive, current flows into the IC according to frequency. If the power supply impedance provided to the power supply circuit is high, it will not be possible to take advantage of IC performance due to input voltage fluctuation. Therefore insert a bypass capacitor close to the  $V^{\dagger}$  pin – the GND pin connection in order to lower high frequency impedance.

#### Undervoltage Lockout Function (UVLO)

The UVLO circuit operating is released above  $V^+ = 2.8V$  (typ.) and IC operation starts. When power supply voltage is low, IC does not operate because the UVLO circuit operates. There is 250mV width hysteresis voltage at rise and decay of power supply voltage. Hysteresis prevents the malfunction at the time of UVLO operating and releasing.

#### **Enable Function (Enable Control)**

The NJW4140 stops the operating and becomes standby status when the EN pin becomes less than 0.9V. The EN pin internally pulls down with  $500k\Omega$ , therefore the NJW4140 becomes standby mode when the EN pin is OPEN. You should connect this pin to V<sup>+</sup> when you do not use Enable function.

#### Soft Start Function (Soft Start)

The output voltage of the converter gradually rises to a set value by the soft start function. The soft start time is 4ms (typ). It is defined with the time of the error amplifier reference voltage becoming from 0V to 0.75V. The soft start circuit operates after the release UVLO. The operating frequency is controlled with a low frequency, approximately 33% of the set value by the timing resistor, until voltage of the IN- pin becomes approximately 0.4V.

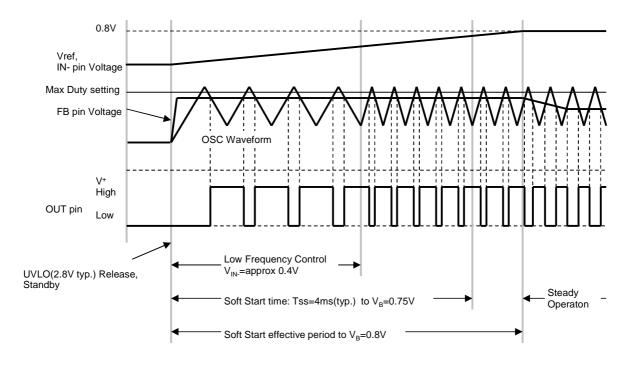


Fig.4. Startup Timing Chart

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#### Description of Block Features (Continued)

#### **Over Current Protection Circuit**

At when the potential difference between the V<sup>+</sup> pin and the SI pin becomes 140mV or more, the over current protection circuit is stopped the switch output. The switching current is detected by inserted current sensing resistor ( $R_{SENSE}$ ) between the SI pin and the GND pin. Fig.5. shows the timing chart of the over current protection detection.

The switching output holds low level until next pulse output at OCP operating. The NJW4140 output returns automatically along with release from the over current condition because the OCP is pulse-by-pulse type.

If voltage of the IN- pin becomes less than 0.4V, the oscillation frequency decreases to one third (33%) and the energy consumption is suppressed.

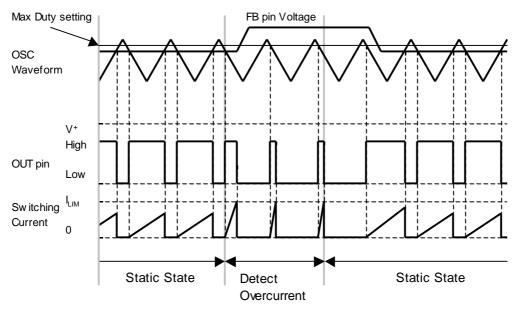


Fig.5. Timing Chart at Over Current Detection

The current waveform contains high frequency superimposed noises due to the parasitic elements of MOSFET, the inductor and the others. Depending on the application, inserting RC low-pass filter between current sensing resistor ( $R_{SENSE}$ ) and the SI pin to prevent the malfunction due to such noise. The time constant of RC low-pass filter should be equivalent to the spike width ( $T \le R \times C$ ) as a rough guide (Fig. 6.).

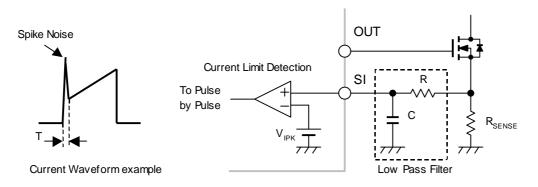


Fig.6. Current Waveform and Filter Circuit

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#### Application Information

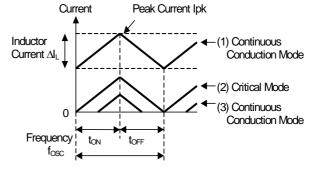
#### Inductors

Large currents flow into inductor, therefore you must provide current capacity that does not saturate.

Reducing L, the size of the inductor can be smaller. However, peak current increases and adversely affecting efficiency.

On the other hand, increasing L, peak current can be reduced at switching time. Therefore conversion efficiency improves, and output ripple voltage reduces. Above a certain level, increasing inductance windings increases loss (copper loss) due to the resistor element.

Ideally, the value of L is set so that inductance current is in continuous conduction mode. However, as the load current decreases, the current waveform changes from (1) CCM: Continuous Conduction Mode  $\rightarrow$  (2) Critical Mode  $\rightarrow$  (3) DCM: Discontinuous Conduction Mode (Fig. 7.).





In discontinuous mode, peak current increases with respect to output current, and conversion efficiency tend to decrease. Depending on the situation, increase L to widen the load current area to maintain continuous mode.

#### **Catch Diode**

When the switch element is in OFF cycle, power stored in the inductor flows via the catch diode to the output capacitor. Therefore during each cycle current flows to the diode in response to load current. Because diode's forward saturation voltage and current accumulation cause power loss, a Schottky Barrier Diode (SBD), which has a low forward saturation voltage, is ideal.

An SBD also has a short reverse recovery time. If the reverse recovery time is long, through current flows when the switching transistor transitions from OFF cycle to ON cycle. This current may lower efficiency and affect such factors as noise generation.

When the switch element is in ON cycle, a reverse voltage flows to SBD. Therefore you should select a SBD that has reverse voltage rating greater than maximum output voltage. The power loss, which stored in output capacitor, will be increase due to increasing reverse current through SBD at high temperature. Therefore, there is cases preferring reverse current characteristics to forward current characteristic in order to improve efficiency.

#### **Switching Element**

You should use a switching element (Nch MOSFET) that is specified for use as a switch. And select sufficiently low  $R_{ON}$  MOSFET at less than  $V_{GS} = 5V$  because the NJW4140 OUT pin voltage is clamped 5.3 (typ.).

However, when the supply voltage of the NJW4140 is low, the OUT pin voltage becomes low. You should select a suitable MOSFET according to the supply voltage specification. (Ref. Driver section)

Large gate capacitance is a source of decreased efficiency. That is charge and discharge from gate capacitance delays switching rise and fall time, generating switching loss.

The spike noise might occur at the time of charge/discharge of gate by the parasitic inductance element. You should insert resistance between the OUT pin and the gate and limit the current for gate protection when gate capacitance is small.

However, it should be noted that the efficiency might decrease because the shape of waves may become duller when resistance is too large. The last fine-tuning should be done on the actual device and equipment.

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#### Application Information (Continued)

#### Input Capacitor

Transient current flows into the input section of a switching regulator responsive to frequency. If the power supply impedance provided to the power supply circuit is large, it will not be possible to take advantage of NJW4140 performance due to input voltage fluctuation. Therefore insert an input capacitor as close to the MOSFET as possible.

#### **Output Capacitor**

An output capacitor stores power from the inductor, and stabilizes voltage provided to the output.

When selecting an output capacitor, you must consider Equivalent Series Resistance (ESR) characteristics, ripple current, and breakdown voltage.

Also, the ambient temperature affects capacitors, decreasing capacitance and increasing ESR (at low temperature), and decreasing lifetime (at high temperature). Concerning capacitor rating, it is advisable to allow sufficient margin.

Output capacitor ESR characteristics have a major influence on output ripple noise. A capacitor with low ESR can further reduce ripple voltage. Be sure to note the following points; when ceramic capacitor is used, the capacitance value decreases with DC voltage applied to the capacitor.

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#### Application Information (Continued)

#### **Board Layout**

In the switching regulator application, because the current flow corresponds to the oscillation frequency, the substrate (PCB) layout becomes an important.

You should attempt the transition voltage decrease by making a current loop area minimize as much as possible. Therefore, you should make a current flowing line thick and short as much as possible. Fig.8. shows a current loop at step-down converter.

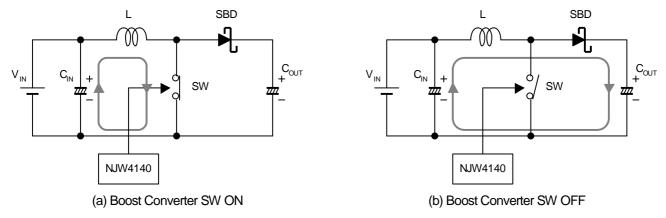


Fig.8. Current Loop at Boost Converter

Concerning the GND line, it is preferred to separate the power system and the signal system, and use single ground point. The voltage sensing feedback line should be as far away as possible from the inductance. Because this line has high impedance, it is laid out to avoid the influence noise caused by flux leaked from the inductance. Fig.9. shows example of wiring at boost converter. Fig.10. shows the PCB layout example.

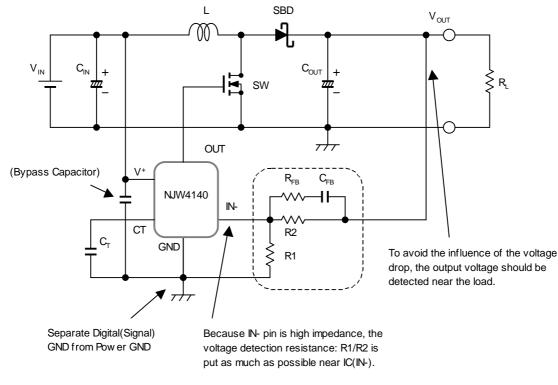


Fig.9. Board Layout at Boost Converter

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# Automotive NJW4140

# **Technical Information**

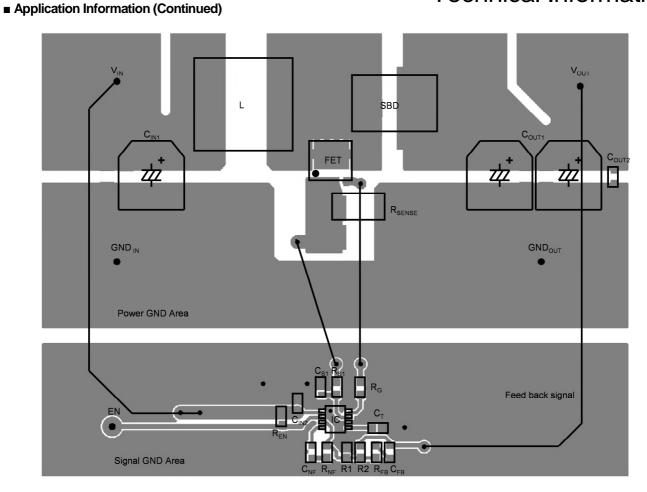


Fig.10. Layout Example (upper view)

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Calculation of Package Power

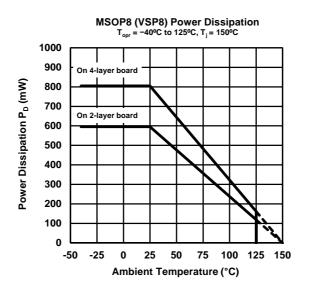
You should consider derating power consumption under using high ambient temperature. Moreover, you should consider the power consumption that occurs in order to drive the switching element.

Supply Voltage	: V*
Quiescent Current	: I <sub>DD</sub>
Oscillation Frequency	: f <sub>OSC</sub>
ON time	: ton
Gate charge amount	: Qg

The gate of MOSFET has the character of high impedance. The power consumption increases by quickening the switching frequency due to charge and discharge the gate capacitance. Power consumption:  $P_D$  is calculated as follows.

 $P_{D} = (V^{+} \times I_{DD}) + (V^{+} \times Qg \times f_{OSC}) [W]$ 

You should consider temperature derating to the calculated power consumption: P<sub>D</sub>. You should design power consumption in rated range referring to the power dissipation vs. ambient temperature characteristics (Fig.11.).



2-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 2-layer FR-4).
4-Layer: Mounted on glass epoxy board (76.2 mm × 114.3 mm × 1.6 mm: based on EIA/JEDEC standard, 4-layer FR-4), internal Cu area: 74.2 mm × 74.2 mm.

Fig.11. Power Dissipation vs. Ambient Temperature Characteristics

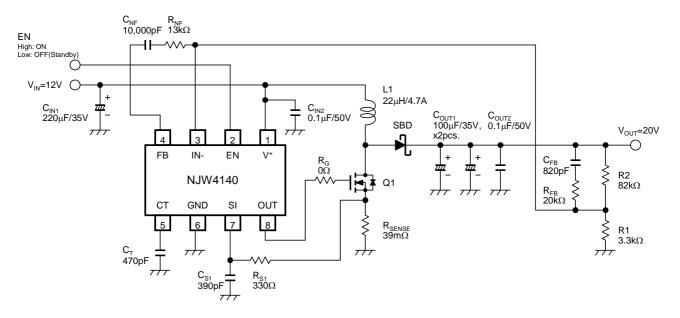
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#### **Step-Up Application Circuit**

 $\begin{array}{ll} \text{IC} & : \text{NJW4140R} \\ \text{Input Voltage} & : \text{V}_{\text{IN}} = 9\text{V to 15V} \\ \text{Output Voltage} & : \text{V}_{\text{OUT}} = 20\text{V} \\ \text{Output Current} & : \text{I}_{\text{OUT}} = 1.5\text{A} \left( @\text{V}_{\text{IN}} = 12\text{V} \right) \\ \text{Oscillation frequency} & : \text{f}_{\text{OSC}} = 300\text{kHz} \end{array}$ 



Reference	Qty.	Part Number	Description	Manufacturer
IC	1	NJW4140R	MOSFET Drive Switching Regulator IC for Boost/Fly-back Converter IC	NJR
Q1	1	TPCA8052-H	Nch MOSFET 40V, 20A	Toshiba
L1	1	CDRH127LDNP-220	Inductor 22µH, 4.7A	Sumida
SBD	1	DE5SC4M	Schottky Diode 40V, 5A	Shindengen
C <sub>IN1</sub>	1	EEEFP1V221AP	Aluminum Electrolytic Capacitor 220µF, 35V	Panasonic
C <sub>IN2</sub>	1	0.1µF	Ceramic Capacitor 1608 0.1µF, 50V, B	Std.
C <sub>OUT1</sub>	2	EEEFP1V101AP	Aluminum Electrolytic Capacitor 100µF, 35V	Panasonic
C <sub>OUT2</sub>	1	0.1µF	Ceramic Capacitor 1608 0.1µF, 50V, B	Std.
C <sub>T</sub>	1	470pF	Ceramic Capacitor 1608 470pF, 50V, CH	Std.
C <sub>NF</sub>	1	10,000pF	Ceramic Capacitor 1608 10,000pF, 50V, B	Std.
C <sub>FB</sub>	1	820pF	Ceramic Capacitor 1608 820pF, 50V, B	Std.
C <sub>S1</sub>	1	390pF	Ceramic Capacitor 1608 390pF, 50V, CH	Std.
R1	1	3.3kΩ	Resistor 1608 3.3kΩ, ±1%, 0.1W	Std.
R2	1	82kΩ	Resistor 1608 82kΩ, ±1%, 0.1W	Std.
R <sub>NF</sub>	1	13kΩ	Resistor 1608 13kΩ, ±1%, 0.1W	Std.
R <sub>FB</sub>	1	20kΩ	Resistor 1608 20kΩ, ±1%, 0.1W	Std.
R <sub>SENSE</sub>	1	UR73D3ATTE39L0F	Resistor 2512 39mΩ, ±1%, 1W	KOA
R <sub>G</sub>	1	0Ω (Short)	Resistor 1608 0Ω, 0.1W	Std.
R <sub>S1</sub>	1	330Ω	Resistor 1608 330Ω, ±1%, 0.1W	Std.

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#### Application Design Examples (Continued)

#### **Setting Oscillation Frequency**

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From the Oscillation frequency vs. Timing Capacitor Characteristic, reads  $C_T = 470$  [pF], t = 3.33 [µs] at  $f_{OSC} = 300$ kHz. Step-Up converter duty ratio is shown with the following equation.

Duty = 
$$\left(1 - \frac{V_{\text{IN}}}{V_{\text{OUT}}}\right) \times 100 = \left(1 - \frac{12}{20}\right) \times 100 = 40$$
 [%]

Therefore,  $t_{ON} = 1.33 \ [\mu s]$ ,  $t_{OFF} = 2.0 \ [\mu s]$ 

#### Selecting Inductance

The inductor's average current equals input current ( $I_{IN}$ ). Estimated efficiency ( $\eta$ ) is 93% and calculates input current as follows.

$$I_{IN} = \frac{V_{OUT} \times I_{OUT}}{\eta \times V_{IN}} = \frac{20 \times 1.5}{0.93 \times 12} = 2.69 \text{ [A]}$$

 $\Delta I_L$  is Inductance ripple current. When  $\Delta I_L$  is 27% of input current:

 $\Delta I_{L} = 0.27 \times I_{IN} = 0.27 \times 2.69 = 0.73 \text{ [A]}$ 

This obtains inductance L.

$$L = \frac{V_{IN}}{\Delta I_L} \times t_{ON} = \frac{12}{0.73} \times 1.33\mu = 22 \ [\mu H]$$

Inductance L is a theoretical value. The optimum value varies according such factors as application specifications and components. Fine-tuning should be done on the actual device. This obtains the peak current lpk at switching time.

$$lpk = l_{lN} + \frac{\Delta l_L}{2} = 2.69 + \frac{0.73}{2} = 3.06 \text{ [A]}$$

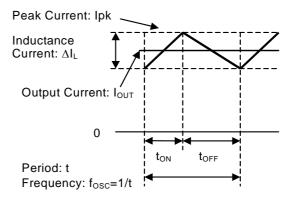


Fig.12. Inductor Current Waveform

The current that flows into the inductance provides sufficient margin for peak current at switching time. In the application circuit, use  $L = 22\mu$ H, 4.5A.

#### **Setting Over Current Detection**

In this application, current limitation value:  $I_{\text{LIMIT}}$  is set to Ipk = 3.5A.

 $I_{LIMIT} = V_{IPK} / R_{SC} = 140 \text{mV} / 39 \text{m}\Omega = 3.59 \text{ [A]}$ 

The limit value increases slightly according to response time from the overcurrent detection with the SI pin to the OUT pin stop.

$$I_{\text{LIMIT}_{\text{DELAY}}} = I_{\text{LIMIT}} + \frac{V_{\text{IN}}}{L} \times T_{\text{DELAY}} = 3.59 + \frac{12}{22\mu} \times 90n = 3.64 \text{ [A]}$$

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#### Application Design Examples (Continued)

#### Selecting the Input Capacitor

The input capacitor corresponds to the input of the power supply. It is required to adequately reduce the impedance of the power supply. The input capacitor selection should be determined by the input ripple current and the maximum input voltage of the capacitor rather than its capacitance value.

The effective input current can be expressed by the following formula.

$$I_{\text{RMS}\_\text{CIN}} = \frac{\Delta I_{\text{L}}}{2\sqrt{3}} = \frac{0.73}{2\sqrt{3}} = 0.21 \text{ [Arms]}$$

When selecting the input capacitor, carry out an evaluation based on the application, and use a capacitor that has adequate margin.

#### Selecting the Output Capacitor

The output capacitor is an important component that determines output ripple noise. Equivalent Series Resistance (ESR), ripple current, and capacitor breakdown voltage are important in determining the output capacitor.

The output ripple noise can be expressed by the following formula.

$$V_{\text{ripple}} = \text{ESR} \times \left(I_{\text{L}} + \frac{\Delta I_{\text{L}}}{2}\right) = 40\text{m} \times \left(2.69 + \frac{0.73}{2}\right) = 122 \text{ [mV]}$$

When selecting output capacitance, select a capacitor that allows for sufficient ripple current. The effective ripple current that flows in a capacitor ( $I_{RMS COUT}$ ) is obtained by the following equation.

$$I_{RMS\_COUT} = I_{OUT} \times \sqrt{\frac{V_{OUT} - V_{IN}}{V_{IN}}} = 1.5 \times \sqrt{\frac{20 - 12}{12}} = 1.22 \text{ [Arms]}$$

Consider sufficient margin, and use a capacitor that fulfills the above spec. In the application circuit, Aluminum Electrolytic Capacitor  $C_{OUT} = 100 \mu F / 35V$  are used by 2 parallel.

#### Setting Output Voltage

The output voltage  $V_{OUT}$  is determined by the relative resistances of R1, R2. The current that flows in R1, R2 must be a value that can ignore the bias current that flows in Error AMP.

$$V_{OUT} = \left(\frac{R2}{R1} + 1\right) \times V_{B} = \left(\frac{82k}{3.3k} + 1\right) \times 0.8 = 20.7 \text{ [V]}$$

It is easy to make a feedback loop, because the error amplifier output connects to FB pin. DC gain affects voltage sensing of the error amplifier. If AC gain increases, it affects stability of regulator due to AC gain which contains switching noise, ripple noise and the others.

Recommended way of feedback is high DC gain and low AC gain.

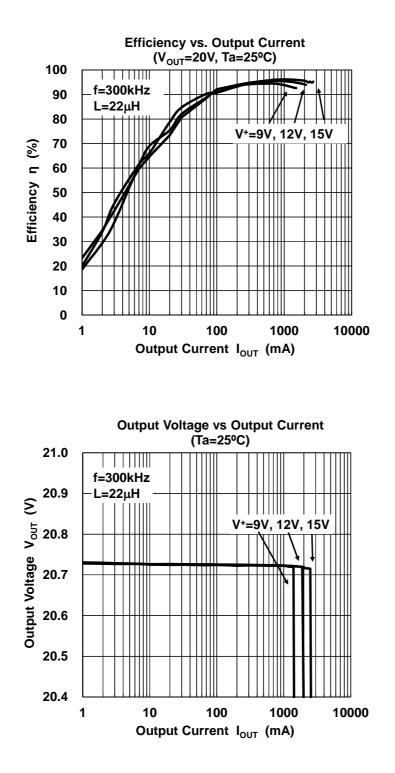
In this application, a feedback resistor  $R_{NF} = 13k\Omega$  and capacitor  $C_{NF} = 10,000pF$  are connected in serial.

However, if the AC gain is lowered too much, it happens slower transient response against fast load changes. The optimum value varies according such factors as application specifications and components. Fine-tuning should be done on the actual device.

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#### Application Characteristics



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# Automotive NJW4140

### MSOP8 (VSP8) JEDEC MO-187-DA

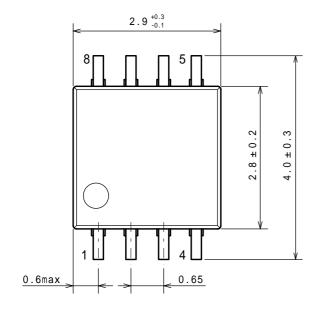
0 ~ 10°

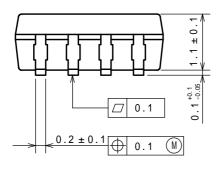
0.127<sup>+0.1</sup><sub>-0.05</sub>

 $0.55 \pm 0.2$ 

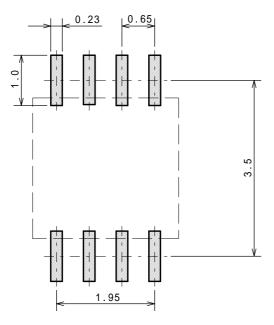
Unit: mm







### ■ EXAMPLE OF SOLDER PADS DIMENSIONS



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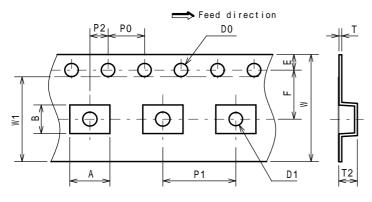


# Automotive NJW4140

### MSOP8 (VSP8) MEET JEDEC MO-187-DA

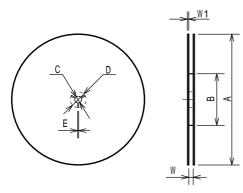
Unit: mm

#### PACKING SPEC TAPING DIMENSIONS



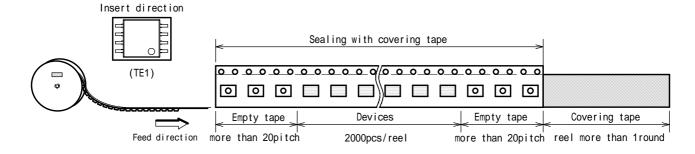
SYMBOL	DIMENSION	REMARKS
A	4.4	BOTTOM DIMENSION
В	3.2	BOTTOM DIMENSION
DO	1.5 <sup>+0.1</sup>	
D1	1.5 <sup>+0.1</sup>	
E	$1.75 \pm 0.1$	
F	$5.5 \pm 0.05$	
PO	$4.0 \pm 0.1$	
P1	8.0±0.1	
P2	2.0±0.05	
Т	$0.30 \pm 0.05$	
T2	2.0 (MAX.)	
W	$12.0 \pm 0.3$	
W1	9.5	THICKNESS 0.1max

#### **REEL DIMENSIONS**

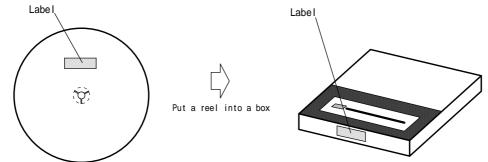


SYMBOL	DIMENSION
A	254 ± 2
В	100 ± 1
С	13±0.2
D	21 ± 0.8
E	2±0.5
W	$13.5 \pm 0.5$
W1	2.0±0.2

TAPING STATE



PACKING STATE

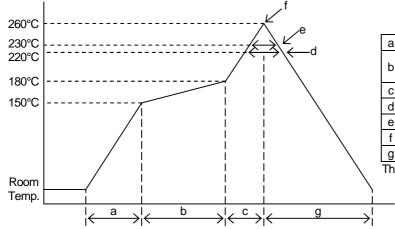


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#### RECOMMENDED MOUNTING METHOD

#### INFRARED REFLOW SOLDERING PROFILE



а	Temperature ramping rate	1 to 4°C/s			
Pre-heating temperature		150 to 180°C			
b	Pre-heating time	60 to 120s			
С	Temperature ramp rate	1 to 4°C/s			
d	220°C or higher time	shorter than 60s			
е	230°C or higher time	shorter than 40s			
f	Peak temperature	lower than 260°C			
g	Temperature ramping rate	1 to 6°C/s			
The	The temperature indicates at the surface of mold peaks				

The temperature indicates at the surface of mold package.

#### ■ REVISION HISTORY

DATE	REVISION	CHANGES
February 19, 2020	Ver.1.0	Initial Release
June 24, 2020	Ver.1.1	Changed datasheet format

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